Phonon dynamics of Mg₃Sb₂

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Thermoelectric materials are attracting interest because they can convert waste heat to electricity. The performance of thermoelectric materials is characterized by the dimensionless figure of merit $ZT = S^2 T / (\rho^* \kappa)$ (S: Seebeck coefficient, ρ: electrical resistivity, κ: thermal conductivity). Zintl phase compounds are one of the most famous systems of thermoelectric materials. In particular, Mg₃Sb₂ is one of promising candidate exhibiting high thermoelectric performance. It shows high value of the dimensionless figure of merit $ZT \sim 1.65$ with quite low lattice thermal conductivity of $\kappa_{\rm L}$ ~ 0.7 W/mK at T = 725 K [1-3]. Although the origin of its low κ_L attracted great attention, phonon dynamics using single crystal has not been well explored.

In this experiment, we conducted inelastic neutron scattering measurements using a tripleaxis spectrometer, HER installed at C1-1 beam port of JRR-3 reactor in JAEA at Tokai. The final neutron energy was fixed at Ef=6.0 meV using a pyrolytic graphite (PG) monochromator and analyzer. Solar-type horizontal collimators with 80' divergence were inserted in between sample and analyzer. Scattering plane was (hk0). A single crystal of Mg₃Sb₂ weighs 7.25g was used for the measurement.

Figure 1 shows typical spectrum of transverse acoustic phonon at a room temperature. A welldefined peak was observed, which allowed to analyze peak position and width appropriately at low energy region. Measurements were performed along Γ -M and Γ -K at room temperature. Based on the observation, phonon dispersions around Γ point were clarified. Further measurements are required to obtain information about temperature dependence to understand their anharmonic behavior.

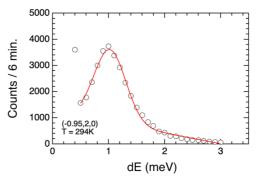


Fig. 1. Inelastic neutron scattering spectrum at q = (-0.95, 2, 0) at a room temperature.

- [1] H. Tamaki et al., Adv. Mater. 28, 10182 (2016).
- [2] J. Zhang et al., Nature Commun. 8, 13901 (2017).

[3] K. Kihou *et al.*, J. Mater. Res. Technol. 10, 438 (2021).